

Features

- Operating voltage 2.7V~5.5V
- Low power consumption
 - Operation: 25mA max. ($V_{CC}=5V$)
10mA max. ($V_{CC}=3V$)
 - Standby: 30 μ A max. ($V_{CC}=5V$)
10 μ A max. ($V_{CC}=3V$)
- Access time: 150ns max. ($V_{CC}=5V$)
250ns max. ($V_{CC}=3V$)
- 262144×8 bits of mask ROM
- Mask options: chip enable $\overline{CE}/\overline{CE1}/\overline{OE1}/\overline{OE1}$, $\overline{CE1}/\overline{CE1}/\overline{OE2}/\overline{OE2}/\overline{NC}$ and output enable $\overline{OE}/\overline{OE}/\overline{NC}$
- TTL compatible inputs and outputs
- Tristate outputs
- Fully static operation
- Package type: 32-pin DIP/SOP/PLCC

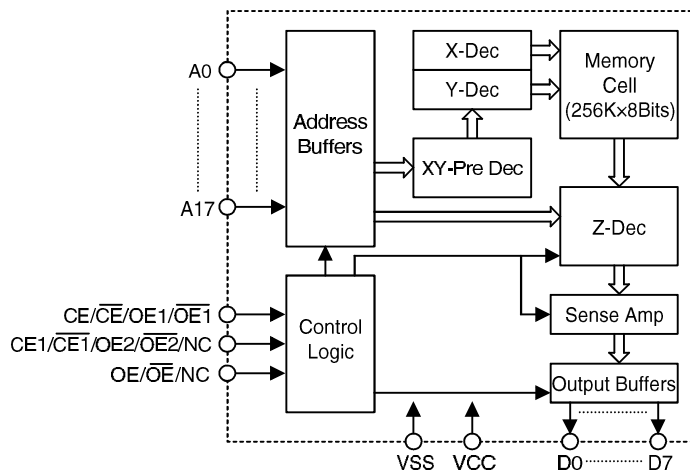
General Description

The HT23C020 is a read-only memory with high performance CMOS storage device whose 2048K of memory is arranged into 262144 words by 8 bits.

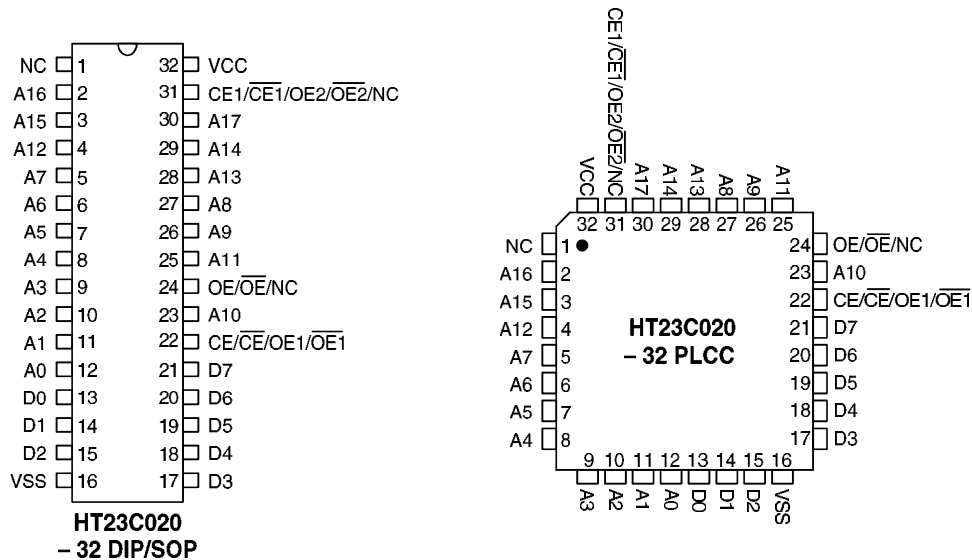
For application flexibility, the chip enable and output enable control pins can be selected as active high or active low. This flexibility not only allows easy interface with most microprocessors, but also eliminates bus contention in

multiple bus microprocessor systems. An additional feature of the HT23C020 is its ability to enter the standby mode whenever the chip enable ($\overline{CE}/\overline{CE1}$ or $\overline{CE1}/\overline{CE1}$) is inactive, thus reducing current consumption to below 30 μ A. The combination of these functions make the chip suitable for high density low power memory applications.

Block Diagram



Pin Assignment



Pin Description

Pin Name	I/O	Description
A0~A17	I	Address inputs
D0~D7	O	Data outputs
CE/CĒ/OE1/OE1̄	I	Chip enable, output enable input
CE1/CE1̄/OE2/OE2̄/NC	I	Chip enable, output enable input
VSS	I	Negative power supply
VCC	I	Positive power supply
OE/OĒ/NC	I	Output enable input
NC	—	No connection

Operation Truth Table

Mode	CE/CĒ	CE1/CE1̄	OE/OĒ	A0~A17	D0~D7
Read	H/L	H/L	H/L	Valid	Data Out
Deselect	H/L	H/L	L/H	X	High Z
Standby	L/H	X	X	X	High Z
Standby	X	L/H	X	X	High Z

Note: H=V_{IH}, L=V_{IL}, X=V_{IH} or V_{IL}

Absolute Maximum Ratings*

Supply Voltage -0.3V to 6V Storage Temperature..... -50°C to 125°C
 Input Voltage..... -0.3V to $V_{CC}+0.3V$ Operating Temperature -40°C to 85°C

*Note: These are stress ratings only. Stresses exceeding the range specified under “Absolute Maximum Ratings” may cause substantial damage to the device. Functional operation of this device at other conditions beyond those listed in the specification is not implied and prolonged exposure to extreme conditions may affect device reliability.

D.C. Characteristics
Supply voltage: 2.7V~3.6V
 $T_a = -40^\circ\text{C}$ to 85°C

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
		VCC	Conditions				
V _{CC}	Operating Voltage	—	—	2.7	—	3.6	V
I _{CC}	Operating Current	3V	O/P Unload, f= 5MHz	—	—	10	mA
V _{IL}	Input Low Voltage	3V	—	V _{SS}	—	0.4	V
V _{IH}	Input High Voltage	3V	—	2.0	—	V _{CC}	V
V _{OL}	Output Low Voltage	3V	I _{OL} = 2.1mA	—	—	0.4	V
V _{OH}	Output High Voltage	3V	I _{OH} = -0.4mA	2.4	—	V _{CC}	V
I _{LI}	Input Leakage Current	3V	V _{IN} = 0 to V _{CC}	—	—	10	μA
I _{LO}	Output Leakage Current	3V	V _{OUT} = 0 to V _{CC}	—	—	10	μA
I _{STB1}	Standby Current	3V	$\overline{CE}=V_{IL}$ $CE=V_{IH}$	—	—	500	μA
I _{STB2}	Standby Current	3V	$CE \leq 0.2V$ $\overline{CE} \geq V_{CC}-0.2V$	—	—	10	μA
C _{IN}	Input Capacitance (See note)	—	f= 1MHz	—	—	10	pF
C _{OUT}	Output Capacitance (See note)	—	f= 1MHz	—	—	10	pF

Note: These parameters are periodically sampled but not 100% tested.

Supply voltage: 4.5V~5.5V

Ta=-40°C to 85°C

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
		V _{CC}	Conditions				
V _{CC}	Operating Voltage	—	—	4.5	—	5.5	V
I _{CC}	Operating Current	5V	O/P Unload, f= 5MHz	—	—	25	mA
V _{IL}	Input Low Voltage	5V	—	V _{SS}	—	0.8	V
V _{IH}	Input High Voltage	5V	—	2.2	—	V _{CC}	V
V _{OL}	Output Low Voltage	5V	I _{OL} = 3.2mA	—	—	0.4	V
V _{OH}	Output High Voltage	5V	I _{OH} = -1mA	2.4	—	V _{CC}	V
I _{LI}	Input Leakage Current	5V	V _{IN} = 0 to V _{CC}	—	—	10	μA
I _{LO}	Output Leakage Current	5V	V _{OUT} = 0 to V _{CC}	—	—	10	μA
I _{STB1}	Standby Current	5V	CE=V _{IL} CE=V _{IH}	—	—	1.5	mA
I _{STB2}	Standby Current	5V	CE≤0.2V CE≥V _{CC} -0.2V	—	—	30	μA
C _{IN}	Input Capacitance (See note)	—	f= 1MHz	—	—	10	pF
C _{OUT}	Output Capacitance (See note)	—	f= 1MHz	—	—	10	pF

Note: These parameters are periodically sampled but not 100% tested.

A.C. Characteristics

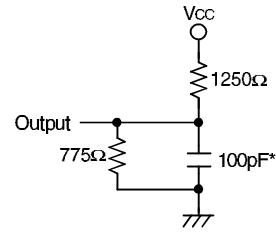
Ta=-40°C to 85°C

Symbol	Parameter	V _{CC} =2.7V~3.6V		V _{CC} =4.5V~5.5V		Unit
		Min.	Max.	Min.	Max.	
t _{CYC}	Cycle Time	250	—	150	—	ns
t _{AA}	Address Access Time	—	250	—	150	ns
t _{ACE}	Chip Enable Access Time	—	250	—	150	ns
t _{AOE}	Output Enable Access Time	—	150	—	80	ns
t _{OH}	Output Hold Time	—	—	10	—	ns
t _{OD}	Output Disable Time (See Note)	—	—	—	70	ns
t _{OE}	Output Enable Time (See Note)	—	—	10	—	ns

Note: These parameters are periodically sampled but not 100% tested.

A.C. test conditions

Output load: see figure right
 Input rise and fall time: 10ns
 Input pulse levels: 0.4V to 2.4V
 Input and output timing reference levels:
 0.8V and 2.0V ($V_{CC}=5V$), 1.5V ($V_{CC}=3V$)



* Including scope and jig

Output load circuit

Functional Description

The HT23C020 has two modes, namely data read mode and standby mode, controlled by $\overline{CE}/\overline{CE1}/\overline{OE1}/\overline{OE1}$, $\overline{CE1}/\overline{CE1}/\overline{OE2}/\overline{OE2}/\overline{NC}$ and $\overline{OE}/\overline{OE}/\overline{NC}$ inputs.

• Standby mode

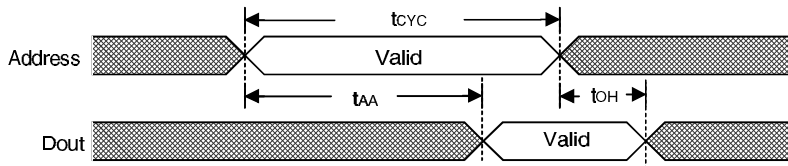
The HT23C020 has lower current consumption, controlled by the chip enable input ($\overline{CE}/\overline{CE}$ and $\overline{CE1}/\overline{CE1}$). When a low/high level is applied to the $\overline{CE}/\overline{CE}$ or $\overline{CE1}/\overline{CE1}$ input, regardless of the output enable ($\overline{OE}/\overline{OE}/\overline{NC}$) states, the chip will enter the standby mode.

• Data read mode

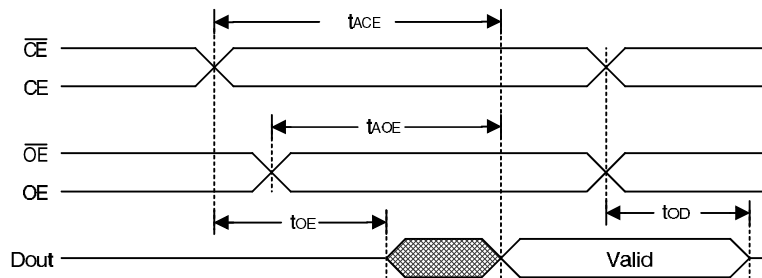
When both the chip enable ($\overline{CE}/\overline{CE}/\overline{OE1}/\overline{OE1}$, $\overline{CE1}/\overline{CE1}/\overline{OE2}/\overline{OE2}/\overline{NC}$) and the output enable ($\overline{OE}/\overline{OE}/\overline{NC}$) are active, the chip is in data read mode. Otherwise, active $\overline{CE}/\overline{CE}$, $\overline{CE1}/\overline{CE1}$ and inactive $\overline{OE}/\overline{OE}/\overline{NC}$ result in deselect mode. The output will remain in Hi-Z state.

Timing Diagrams

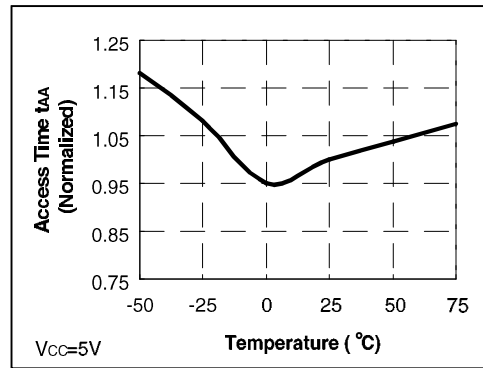
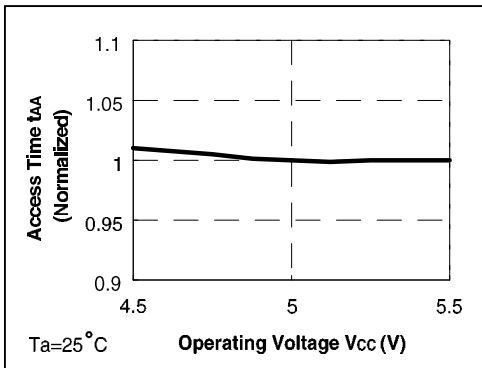
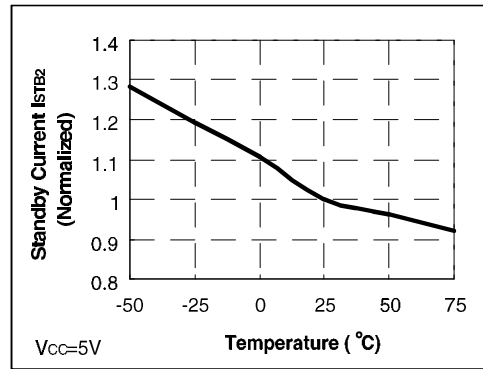
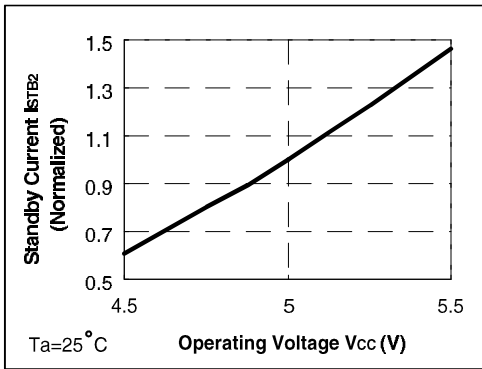
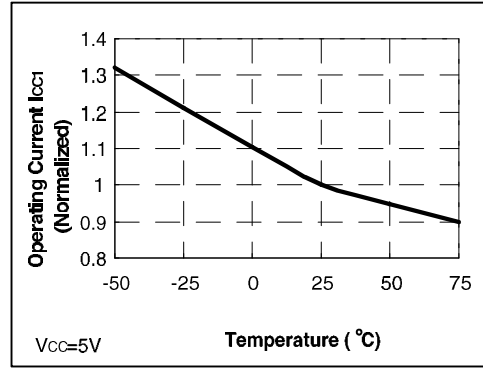
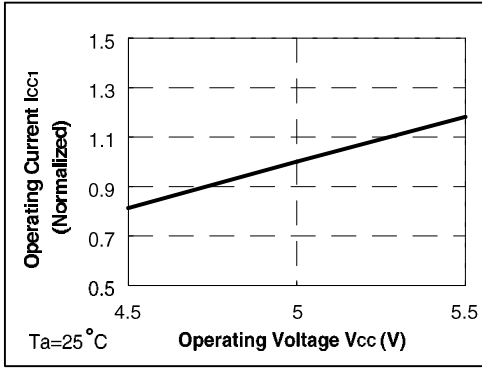
- Propagation delay due to address ($\overline{CE}/\overline{CE}/\overline{OE1}/\overline{OE1}$, $\overline{CE1}/\overline{CE1}/\overline{OE2}/\overline{OE2}$ and $\overline{OE}/\overline{OE}$ are active)

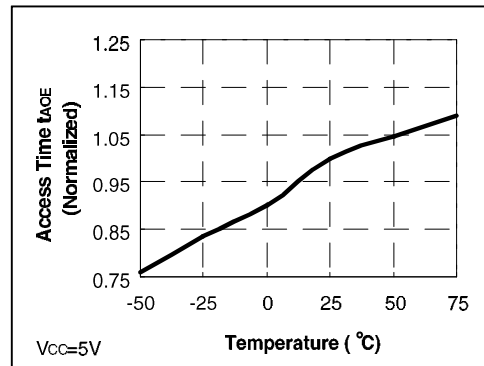
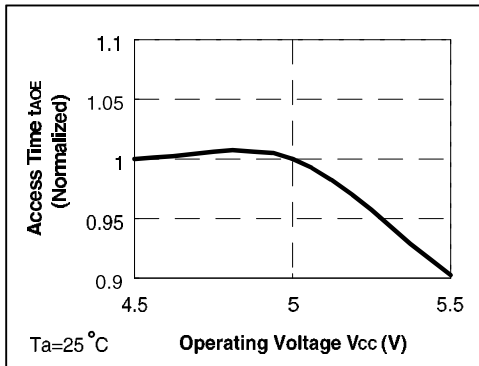
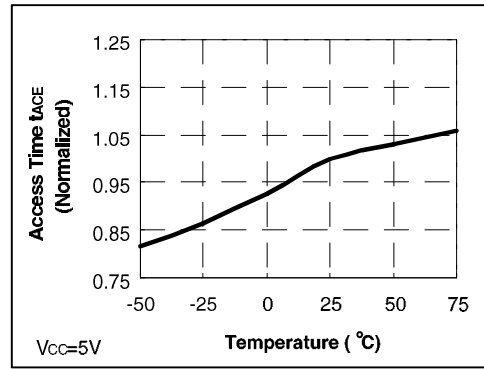
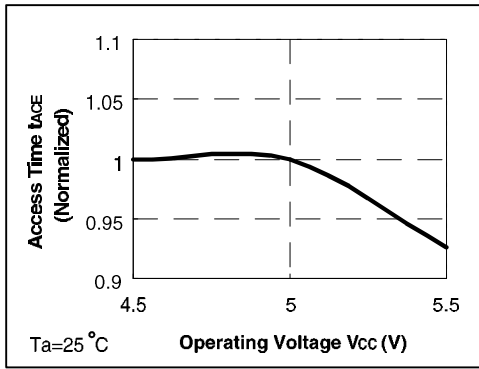


- Propagation delay due to chip and output enable (address valid)



Characteristic Curves





HT23C020 MASK ROM ORDERING SHEET

Custom: _____

Input Medium:

EPROM DISK File (Mail Address: romfile@holtek.com.tw) OTHER _____

User No.	Type/Ref. Name	Q'ty	Check Sum	Memory Address	
				Start	End

Control Pin and Package Form Option:

(a) 32 Pin Type Pin 22: _____ (C1) CE (C2) \overline{CE} (D1) OE1 (D2) $\overline{OE1}$
 Pin 31: _____ (C1) CE1 (C2) $\overline{CE1}$ (C3) NC (D1) OE2 (D2) $\overline{OE2}$ (D3) NC
 Pin 24: _____ (1) OE (2) \overline{OE} (3) NC
 (b) Package Form: _____ (1) Chip Form (2) 32 DIP (3) 32 SOP (4) 32 PLCC

Companion User No. _____

Package Marking : _____

Delivery Date : _____ Q'ty: _____

CUSTOM CONFIRMED BY:

 (NAME, DATE, POSITION & CO. CHOP)

HOLTEK CONFIRMED BY:

 (SALES)

 (SALES MANAGER)